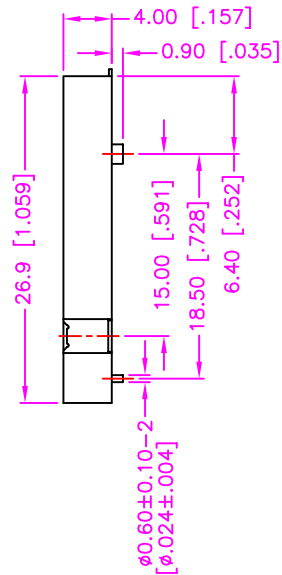
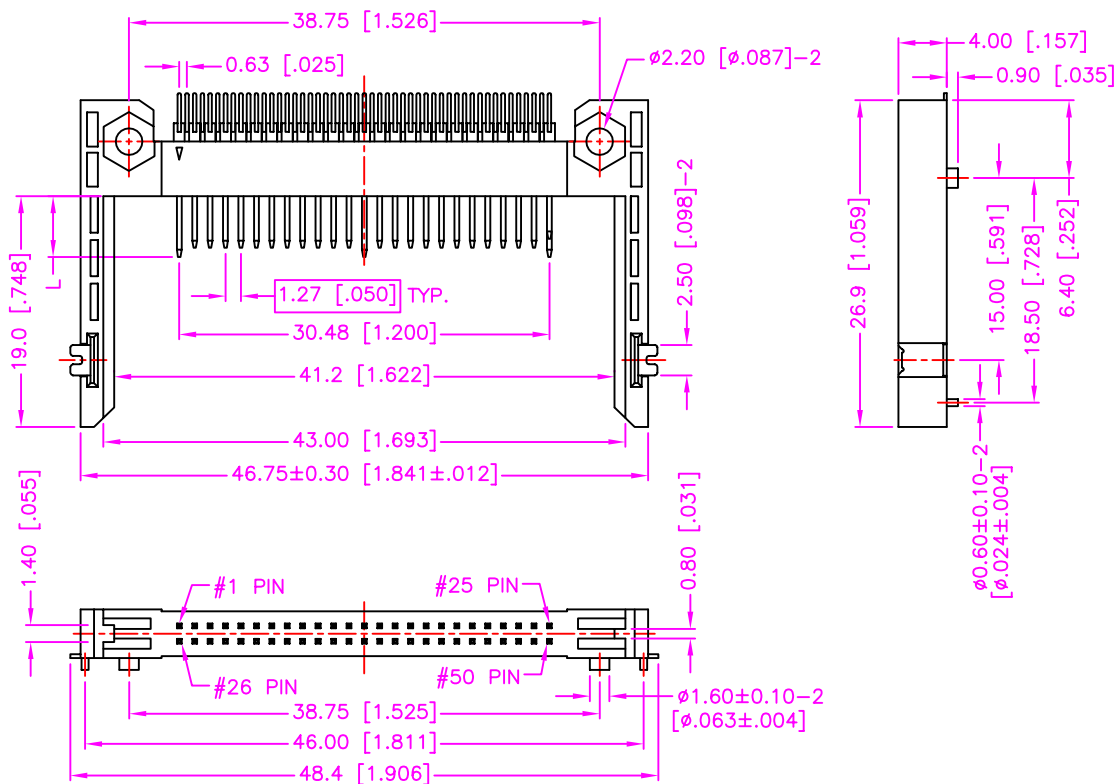


REV.	DESCRIPTION	DATE
—	RELEASE	Aug. 23, 2002
1	DRAW MODIFY	Sep. 25, 2002
2	P/N MODIFY	Oct. 03, 2002



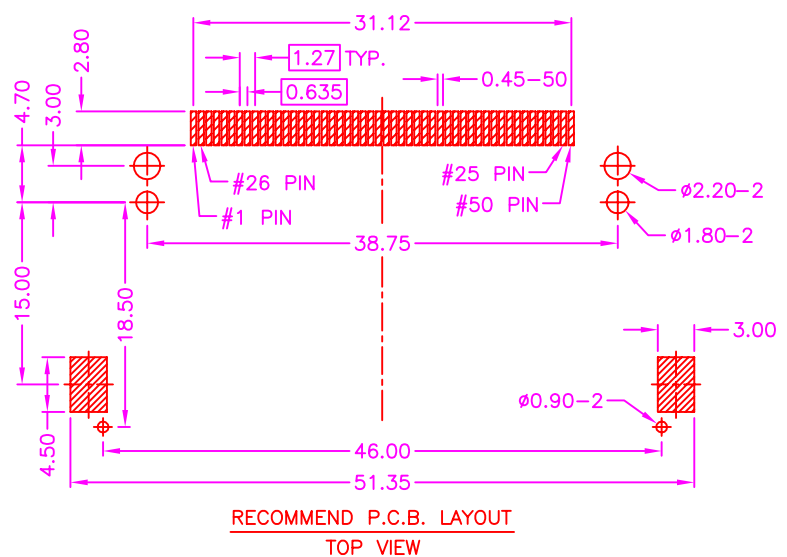
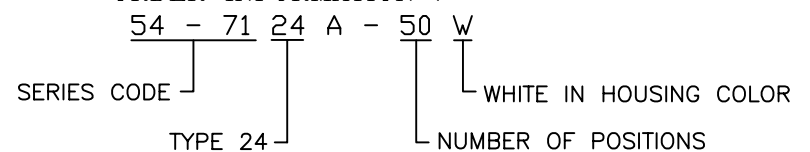
**MATERIALS**

1. HOUSING : HI.-TEMP. PLASTIC (UL 94V-0).
2. TERMINAL : COPPER ALLOY, GOLD PLATING ON CONTACT AREA, TIN PLATING ON SOLDER TAIL.

**SPECIFICATION**

1. CURRENT RATING : 0.5 AMP. MAX.
2. DIELECTRIC WITHSTANDING VOLTAGE : 500V AC R.M.S. FOR ONE MINUTE.
3. INSULATION RESISTANCE : 1000M OHMS MIN. AT 500V DC.
4. OPERATING TEMPERATURE : -25°C TO +60°C.
5. MAX. PROCESSING TEMP. : 230°C FOR 30 ~ 60 SECONDS.

**ORDER INFORMATION :**



DIM. : L±0.15 [±.006]	PIN NUMBER
3.50 [.138]	25, 26
4.25 [.167]	ALL OTHER PINS
5.00 [.197]	1, 13, 38, 50

TOLERANCE .0=±0.30 [.012] .00=±0.20 [.008] .000=±.XXX .0000=±. ANG.=±3°	DRAWER <i>Katherlin</i> CHECK <i>JUE</i> APP'D <i>ALEX</i>	<b>Astron</b> ASTRON TECHNOLOGY CORP. NAME MEMORY CARD CF CARD, 1.27mm PITCH P.C.B. MOUNT, SMT, MALE (NORMAL TYPE-0.00mm STANDOFF)
 UNITS : mm [inch]	PRODUCT SPEC. —	
SCALE NONE	SIZE A4	DRAW NO. C254-7131
SHEET 1 OF 1	REV. C	10019